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### STPS200170TV1

## High voltage power Schottky rectifier

### **Features**

- Negligible switching losses
- Avalanche rated
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Insulated package: ISOTOP
  - Electrical insulation = 2500 V rms, capacitance = 45 pF

### **Description**

This high voltage Schottky rectifier is suited for high frequency switch mode power supplies.

Packaged in ISOTOP, this device is intended for use in the secondary rectification of applications.

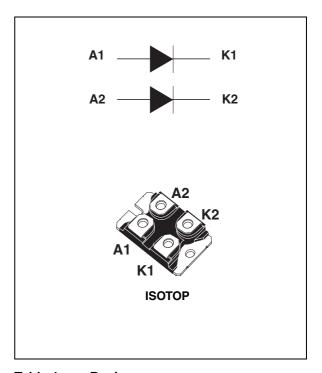


Table 1. Device summary

I <sub>F(AV)</sub>	2 x 100 A
V <sub>RRM</sub>	170 V
Tj	150 °C
V <sub>F</sub> (typ)	0.63 V

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#### **Characteristics** 1

Table 2. Absolute ratings - limiting values per diode at  $T_{amb}$  = 25 °C, unless otherwise specified

Symbol	Parameter			Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage			170	V
I <sub>F(RMS)</sub>	Forward rms current			200	Α
I <sub>F(AV)</sub>	Average forward current, $\delta = 0.5$		T <sub>c</sub> = 105 °C per diode	100	Α
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms sinusoidal		700	Α
P <sub>ARM</sub>	Repetitive peak avalanche power	t <sub>p</sub> = 1 μs, T <sub>j</sub> = 25 °C		100000	W
T <sub>stg</sub>	Storage temperature range			-55 to + 150	°C
T <sub>j</sub>	Maximum operating junction temperature <sup>(1)</sup>			150	°C

 $<sup>\</sup>frac{dP_{tot}}{dT_i} < \frac{1}{R_{th(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal parameters

Symbol	Parameter		Value	Unit
D .	Junction to case Per diode Total	Per diode	0.52	
$R_{th(j-c)}$		0.31	°C/W	
R <sub>th(c)</sub>	Coupling thermal resistance		0.1	

When the diodes are used simultaneously:

 $T_{j(diode1)} = P_{(diode1)} X R_{th(j-c)} (per diode) + P_{(diode2)} X R_{th(c)}$ 

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	V- <b>-</b> V	·	-	200	μΑ
'R	Theverse leakage current	T <sub>j</sub> = 125 °C	$V_R = V_{RRM}$	-	30	100	mA
	T <sub>j</sub> = 25 °C		I <sub>F</sub> = 100 A	-	-	0.85	
V (2)	V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	T <sub>j</sub> = 150 °C	IF = 100 A	-	0.63	0.68	V
v <sub>E</sub> , ,		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 200 A	-	-	0.975	V
		T <sub>j</sub> = 150 °C		-	0.78	0.86	

<sup>1.</sup> Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2 %

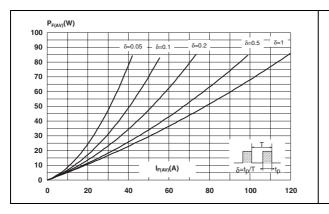
To evaluate the conduction losses use the following equation: P = 0.5 x  $I_{F(AV)}$  + 0.0018  $I_{F}^{2}_{(RMS)}$ 

$$P = 0.5 \times I_{E(AV)} + 0.0018 I_{E^{2}(BMS)}$$

<sup>2.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2 %

STPS200170TV1 Characteristics

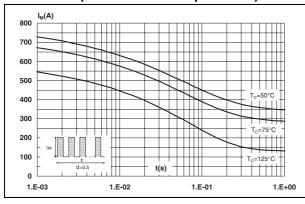
Figure 1. Conduction losses versus average Figure 2. Average forward current versus ambient temperature  $(\delta=0.5,\,per\,diode)$ 



I<sub>F(AV)</sub>(A)
120
100
80
60
40
20
δ=tp/T tp T<sub>amb</sub>(°C)
0
25 50 75 100 125 150

Figure 3. Non-repetitive surge peak forward current vesus overload duration (maximum values per diode)

Figure 4. Relative variation of thermal impedance (junction to case) versus pulse duration



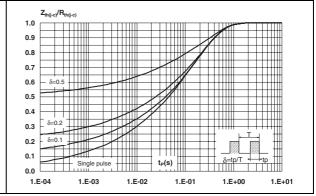
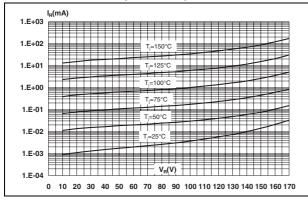
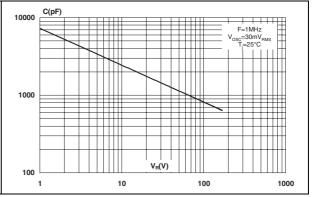


Figure 5. Reverse leakage current versus reverse voltage applied (typical values per diode)

Figure 6. Junction capacitances versus reverse voltage applied (typical values per diode)





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Figure 7. Forward voltage drop versus forward current (per diode, low level)

 $I_{FM}(A)$ 50 45 Tj=150°C 40 35 30 Ti=25°C 25 20 15 10 0 0.2 0.6 0.7 0.0 0.1 0.3 0.4 0.8

Figure 8. Forward voltage drop versus forward current (per diode, high level)

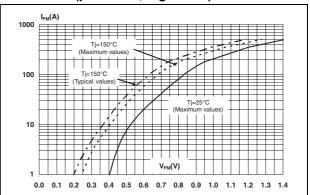
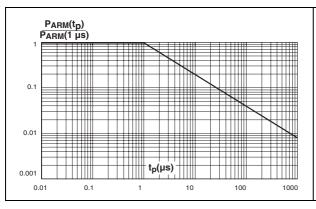
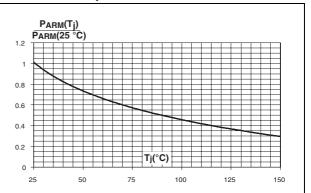


Figure 9. Normalized avalanche power derating versus pulse duration

Figure 10. Normalized avalanche power derating versus junction temperature



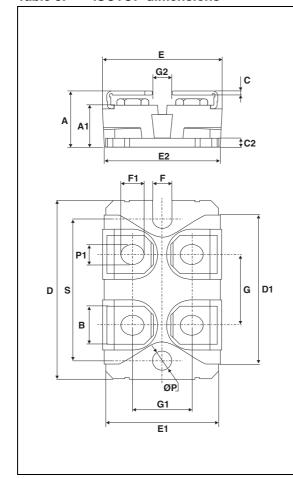


## 2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 5. ISOTOP dimensions



	Dimensions				
Ref.	Millim	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
Α	11.80	12.20	0.465	0.480	
A1	8.90	9.10	0.350	0.358	
В	7.8	8.20	0.307	0.323	
С	0.75	0.85	0.030	0.033	
C2	1.95	2.05	0.077	0.081	
D	37.80	38.20	1.488	1.504	
D1	31.50	31.70	1.240	1.248	
Е	25.15	25.50	0.990	1.004	
E1	23.85	24.15	0.939	0.951	
E2	24.80 typ.		0.976 typ.		
G	14.90	15.10	0.587	0.594	
G1	12.60	12.80	0.496	0.504	
G2	3.50	4.30	0.138	0.169	
F	4.10	4.30	0.161	0.169	
F1	4.60	5.00	0.181	0.197	
Р	4.00	4.30	0.157	0.69	
P1	4.00	4.40	0.157	0.173	
S	30.10	30.30	1.185	1.193	

Ordering information STPS200170TV1

# **3** Ordering information

 Table 6.
 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
STPS200170TV1	STPS200170TV1	ISOTOP	27 g without screws	10 with screws	Tube

# 4 Revision history

Table 7. Document revision history

Date	Revision	Changes
14-Nov-2005	1	First issue.
09-Sep-2011	2	Updated $V_{F max}$ at $T_j = 25$ °C and $I_F = 100$ A to 0.85 V.

Doc ID 11857 Rev 2

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